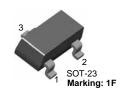


MMBT5550 NPN General Purpose Amplifier

 This device is designed for general purpose high voltage amplifiers and gas discharge display drivers.



1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter		Value	Units
V _{CEO}	Collector-Emitter Voltage		140	V
V _{CBO}	Collector-Base Voltage		160	V
V _{EBO}	Emitter-Base Voltage		6.0	V
I _C	Collector current	- Continuous	600	mA
T _J , T _{stg}	Junction and Storage Temperature		-55 ~ +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. NOTES:

Electrical Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charact	eristics			•	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	$I_C = 1.0 \text{mA}, I_B = 0$	140		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	160		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10 \text{mA}, I_C = 0$	6.0		V
I _{CBO}	Collector Cutoff Current	V _{CB} = 100V, I _E = 0 V _{CB} = 100V, I _E = 0, T _a = 100°C		100 100	nA μA
I _{EBO}	Emitter Cutoff Current	$V_{EB} = 4.0V, I_{C} = 0$		50	nA
On Charact	eristics				
h _{FE}	DC Current Gain	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V $I_C = 10$ mA, $V_{CE} = 5.0$ V $I_C = 50$ mA, $V_{CE} = 5.0$ V	60 60 20	250	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 10mA, I _B = 1.0mA I _C = 50mA, I _B = 5.0mA		0.15 0.25	V V
V _{BE(sat)}	Base-Emitter On Voltage	I _C = 10mA, I _B = 1.0mA I _C = 50mA, I _B = 5.0mA		1.0 1.2	V V

^{1.} These ratings are based on a maximum junction temperature of 150 degrees ${\bf C}.$

^{2.} These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Parameter Test Condition		Max.	Units	
Small Signa	Small Signal Characteristics					
f _T	Current Gain Bandwidth Product	I _C = 10mA, V _{CE} = 10V, f = 100MHz	50		MHz	
C _{obo}	Output Capacitance	V _{CB} = 10V, I _E = 0, f = 1.0MHz		6.0	pF	
C _{ibo}	Input Capacitance	$V_{BE} = 0.5V, I_{C} = 0, f = 1.0MHz$		30	pF	

Thermal Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
P _D	Total Device Dissipation Derate above 25°C	350 2.8	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

^{*} Device mounted on FR-4 PCB 1.6" \times 1.6" \times 0.06."

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
1F	MMBT5550	SOT-23	7"		3,000

Typical Performance Characteristics

Figure 1. Typical Pulsed Current Gain vs Collector Current

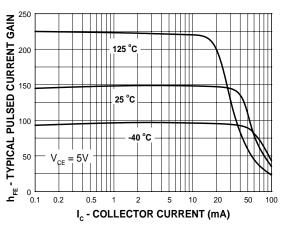


Figure 3. Base-Emitter Saturation Voltage vs Collector Current

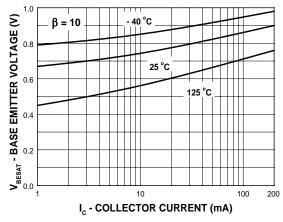


Figure 5. Collector Cutoff Current vs Ambient Temperature

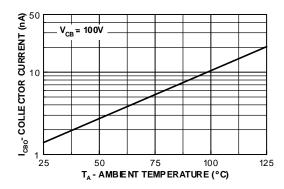


Figure 2. Collector-Emitter Saturation Voltage vs Collector Current

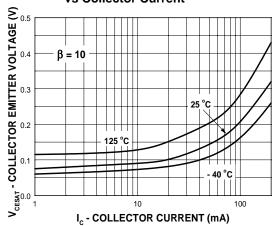


Figure 4. Base-Emitter On Voltage vs Collector Current

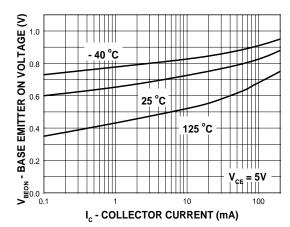
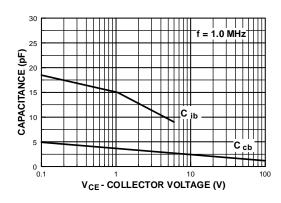


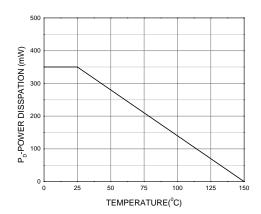
Figure 6. Input and Output Capacitance vs Reverse Voltaget



3 www.fairchildsemi.com

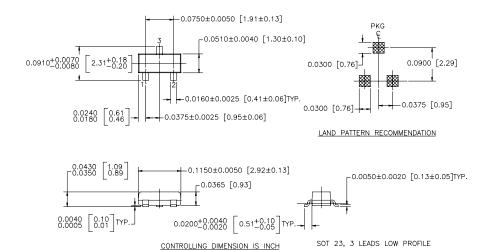
Typical Performance Characteristics (Continued)

Figure 7. Power Dissipation vs Ambient Temperature



Mechanical Dimensions

SOT-23



NOTE: UNLESS OTHERWISE SPECIFIED

- 1. STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
- 2. REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

Dimensions in Millimeters

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Build it Now™	FRFET™	MicroFET™	QS™	TINYOPTO™
CoolFET™	GlobalOptoisolator™	MicroPak™	QT Optoelectronics™	TruTranslation™
$CROSSVOLT^{TM}$	GTO™	MICROWIRE™	Quiet Series™	UHC™
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EcoSPARK™	I ² C™	MSXPro™	RapidConnect™	UniFET™
E ² CMOS™	i-Lo™	OCXTM	μSerDes™	VCX™
EnSigna™	ImpliedDisconnect™	OCXPro™	SILENT SWITCHER®	Wire™
FACT™	IntelliMAX™	OPTOLOGIC [®]	SMART START™	
FACT Quiet Series™		OPTOPLANAR™	SPM™	
A	and the account of TM	PACMAN™	Stealth™	
Across the board. Arour	na the worla.™	POP™	SuperFET™	
The Power Franchise®	TM	Power247™	SuperSOT™-3	
Programmable Active D	roop™	PowerEdge™	SuperSOT™-6	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

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